

PRODUCT SPECIFICATION

11500-O

UV Adhesive

Description:

Engineered for complex assembly applications, this single-component, high-performance multi-cure adhesive utilizes UV light, thermal exposure, or an anaerobic activator to achieve full cure. This versatile triple-cure mechanism ensures complete polymerization in shadowed regions or opaque geometries where UV light penetration is restricted.

Featuring a high viscosity profile and a controlled medium cure speed, the adhesive permits accurate component alignment prior to setting. It offers superior substrate wetting, minimal volumetric shrinkage, and exceptional joint flexibility, providing outstanding stress absorption and environmental resistance against temperature cycling, moisture, and chemical exposure.

Typical Properties of Cured/Uncured Material:

Liquid State		Cured State	
Base	Urethane Methacrylate	Tensile Strength, ASTM D882 (psi)	4800
Colour	Clear / Amber	Elongation @ break (%)	60
Specific Gravity (25°C)	1.1	Hardness, ASTM D2240 Shore D	75
Refraction Index (25°C)	1.49	Flash Point (°C)	95
Viscosity (cP)	10000-12500		

UV Curing System:

Lamp Type	5" x 5" Flood	3/16" Spot	1" x 6" Focused
Max. Lamp Intensity @ 365 nm	300 mW/cm2	4000 mW/cm2	8000 mW/cm2
Adhesive Absorption Range (nm)	300 - 480	300 - 480	300 - 480
Cure Speed (Sec)			
Glass to Glass Bonding	4	6	<2
Surface Cure Speed	8	7	<2

Bond Strength

(Shear Strength, psi, ASTM D4501):

Substrate	psi	N/mm ²
Tensile Shear Strength	2400-2900	16-20

Cure Conditions:

Cure can be achieved using both low and high-intensity UV light sources. Under a low UV intensity of 30 mW/cm, highly transmissive substrates with joint gaps under 0.25 mm (0.010") cure in 5 seconds, while gaps of 1.75 mm to 2.25 mm (0.070" to 0.090") cure within 10 to 20 seconds. Under a high UV intensity of 100 mW/cm, highly transmissive substrates with gaps under 0.25 mm (0.010") cure in 2 seconds, while larger gaps of 2.5 mm to 5.0 mm (0.100" to 0.200") achieve full cure within 10 to 20 seconds.

Directions For Use:

This adhesive is UV sensitive. Exposure to daylight, UV light and artificial lighting should be kept to a minimum during storage and handling. Adhesive product should be dispensed from applicators with black feed lines. For best performance bond surfaces should be clean and free from grease.

UV cure rate is depends on lamp intensity, distance from light source, depth of cure needed or bond line gap and light transmittance of the substrate through which the radiation must pass.

Recommended intensity for cure in an adhesive application are 40-mW/cm2 minimums with an exposure time of 5-6 times the fixture time at this same intensity. For tack free surface cure, as necessary in coating, potting or tacking applications, higher intensity UV is required.

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